

# 74ABT573

## Octal D-Type Latch with 3-STATE Outputs

### Features

- Inputs and outputs on opposite sides of package allow easy interface with microprocessors
- Useful as input or output port for microprocessors
- Functionally identical to ABT373
- 3-STATE outputs for bus interfacing
- Output sink capability of 64mA, source capability of 32mA
- Guaranteed output skew
- Guaranteed multiple output switching specifications
- Output switching specified for both 50pF and 250pF loads
- Guaranteed simultaneous switching, noise level and dynamic threshold performance
- Guaranteed latchup protection
- High-impedance, glitch-free bus loading during entire power up and power down
- Nondestructive, hot insertion capability

### General Description

The ABT573 is an octal latch with buffered common Latch Enable (LE) and buffered common Output Enable ( $\overline{OE}$ ) inputs.

This device is functionally identical to the ABT373 but has broadside pinouts.

### Ordering Information

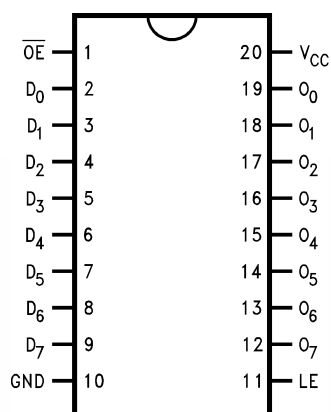
| Order Number | Package Number | Package Description                                                         |
|--------------|----------------|-----------------------------------------------------------------------------|
| 74ABT573CSC  | M20B           | 20-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-013, 0.300" Wide  |
| 74ABT573CSJ  | M20D           | 20-Lead Small Outline Package (SOP), EIAJ TYPE II, 5.3mm Wide               |
| 74ABT573CMSA | MSA20          | 20-Lead Shrink Small Outline Package (SSOP), JEDEC MO-150, 5.3mm Wide       |
| 74ABT573CMTC | MTC20          | 20-Lead Thin Shrink Small Outline Package (TSSOP), JEDEC MO-153, 4.4mm Wide |

Device also available in Tape and Reel. Specify by appending suffix letter "X" to the ordering number.



All packages are lead free per JEDEC: J-STD-020B standard.

## Connection Diagram



## Pin Descriptions

| Pin Names                      | Descriptions                             |
|--------------------------------|------------------------------------------|
| D <sub>0</sub> –D <sub>7</sub> | Data Inputs                              |
| LE                             | Latch Enable Input (Active HIGH)         |
| $\overline{OE}$                | 3-STATE Output Enable Input (Active LOW) |
| O <sub>0</sub> –O <sub>7</sub> | 3-STATE Latch Outputs                    |

## Functional Description

The ABT573 contains eight D-type latches with 3-STATE output buffers. When the Latch Enable (LE) input is HIGH, data on the D<sub>n</sub> inputs enters the latches. In this condition the latches are transparent, i.e., a latch output will change state each time its D input changes. When LE is LOW the latches store the information that was present on the D inputs a setup time preceding the HIGH-to-LOW transition of LE. The 3-STATE buffers are controlled by the Output Enable ( $\overline{OE}$ ) input. When  $\overline{OE}$  is LOW, the buffers are in the bi-state mode. When  $\overline{OE}$  is HIGH the buffers are in the high impedance mode but this does not interfere with entering new data into the latches.

## Function Table

| Inputs          |    |   | Outputs        |
|-----------------|----|---|----------------|
| $\overline{OE}$ | LE | D | O              |
| L               | H  | H | H              |
| L               | H  | L | L              |
| L               | L  | X | O <sub>0</sub> |
| H               | X  | X | Z              |

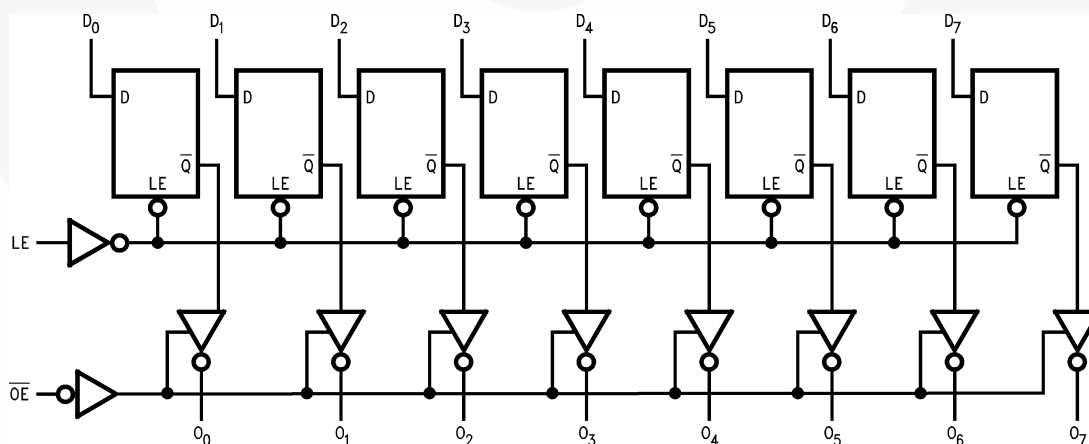
H = HIGH Voltage Level

L = LOW Voltage Level

X = Immaterial

O<sub>0</sub> = Value stored from previous clock cycle

## Logic Diagram



Please note that this diagram is provided only for the understanding of logic operations and should not be used to estimate propagation delays.

## Absolute Maximum Ratings

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only.

| Symbol    | Parameter                                                                  | Rating                                                        |
|-----------|----------------------------------------------------------------------------|---------------------------------------------------------------|
| $T_{STG}$ | Storage Temperature                                                        | $-65^{\circ}\text{C}$ to $+150^{\circ}\text{C}$               |
| $T_A$     | Ambient Temperature Under Bias                                             | $-55^{\circ}\text{C}$ to $+125^{\circ}\text{C}$               |
| $T_J$     | Junction Temperature Under Bias                                            | $-55^{\circ}\text{C}$ to $+150^{\circ}\text{C}$               |
| $V_{CC}$  | $V_{CC}$ Pin Potential to Ground Pin                                       | $-0.5\text{V}$ to $+7.0\text{V}$                              |
| $V_{IN}$  | Input Voltage <sup>(1)</sup>                                               | $-0.5\text{V}$ to $+7.0\text{V}$                              |
| $I_{IN}$  | Input Current <sup>(1)</sup>                                               | $-30\text{mA}$ to $+5.0\text{mA}$                             |
| $V_O$     | Voltage Applied to Any Output<br>Disabled or Power-Off State<br>HIGH State | $-0.5\text{V}$ to $5.5\text{V}$<br>$-0.5\text{V}$ to $V_{CC}$ |
|           | Current Applied to Output in LOW State (Max.)                              | twice the rated $I_{OL}$ (mA)                                 |
|           | DC Latchup Source Current                                                  | $-500\text{mA}$                                               |
|           | Over Voltage Latchup (I/O)                                                 | 10V                                                           |

### Note:

1. Either voltage limit or current limit is sufficient to protect inputs.

## Recommended Operating Conditions

The Recommended Operating Conditions table defines the conditions for actual device operation. Recommended operating conditions are specified to ensure optimal performance to the datasheet specifications. Fairchild does not recommend exceeding them or designing to absolute maximum ratings.

| Symbol                | Parameter                    | Rating                                         |
|-----------------------|------------------------------|------------------------------------------------|
| $T_A$                 | Free Air Ambient Temperature | $-40^{\circ}\text{C}$ to $+85^{\circ}\text{C}$ |
| $V_{CC}$              | Supply Voltage               | $+4.5\text{V}$ to $+5.5\text{V}$               |
| $\Delta V / \Delta t$ | Minimum Input Edge Rate      |                                                |
|                       | Data Input                   | 50mV/ns                                        |
|                       | Enable Input                 | 20mV/ns                                        |

## DC Electrical Characteristics

| Symbol           | Parameter                                      |                 | V <sub>CC</sub> | Conditions                                                                                                  | Min. | Typ. | Max. | Units  |
|------------------|------------------------------------------------|-----------------|-----------------|-------------------------------------------------------------------------------------------------------------|------|------|------|--------|
| V <sub>IH</sub>  | Input HIGH Voltage                             |                 |                 | Recognized HIGH Signal                                                                                      | 2.0  |      |      | V      |
| V <sub>IL</sub>  | Input LOW Voltage                              |                 |                 | Recognized LOW Signal                                                                                       |      |      | 0.8  | V      |
| V <sub>CD</sub>  | Input Clamp Diode Voltage                      |                 | Min.            | I <sub>IN</sub> = -18mA                                                                                     |      |      | -1.2 | V      |
| V <sub>OH</sub>  | Output HIGH Voltage                            |                 | Min.            | I <sub>OH</sub> = -3mA                                                                                      | 2.5  |      |      | V      |
|                  |                                                |                 |                 | I <sub>OH</sub> = -32mA                                                                                     | 2.0  |      |      |        |
| V <sub>OL</sub>  | Output LOW Voltage                             |                 | Min.            | I <sub>OL</sub> = 64mA                                                                                      |      |      | 0.55 | V      |
| I <sub>IH</sub>  | Input HIGH Current                             |                 | Max.            | V <sub>IN</sub> = 2.7V <sup>(3)</sup>                                                                       |      |      | 1    | μA     |
|                  |                                                |                 |                 | V <sub>IN</sub> = V <sub>CC</sub>                                                                           |      |      | 1    |        |
| I <sub>BVI</sub> | Input HIGH Current Breakdown Test              |                 | Max.            | V <sub>IN</sub> = 7.0V                                                                                      |      |      | 7    | μA     |
| I <sub>IL</sub>  | Input LOW Current                              |                 | Max.            | V <sub>IN</sub> = 0.5V <sup>(3)</sup>                                                                       |      |      | -1   | μA     |
|                  |                                                |                 |                 | V <sub>IN</sub> = 0.0V                                                                                      |      |      | -1   |        |
| V <sub>ID</sub>  | Input Leakage Test                             |                 | 0.0             | I <sub>ID</sub> = 1.9 μA, All Other Pins Grounded                                                           | 4.75 |      |      | V      |
| I <sub>OZH</sub> | Output Leakage Current                         |                 | 0-5.5V          | V <sub>OUT</sub> = 2.7V, $\overline{OE}$ = 2.0V                                                             |      |      | 10   | μA     |
| I <sub>OZL</sub> | Output Leakage Current                         |                 | 0-5.5V          | V <sub>OUT</sub> = 0.5V, $\overline{OE}$ = 2.0V                                                             |      |      | -10  | μA     |
| I <sub>OS</sub>  | Output Short-Circuit Current                   |                 | Max.            | V <sub>OUT</sub> = 0.0V                                                                                     | -100 |      | -275 | mA     |
| I <sub>CEX</sub> | Output HIGH Leakage Current                    |                 | Max.            | V <sub>OUT</sub> = V <sub>CC</sub>                                                                          |      |      | 50   | μA     |
| I <sub>ZZ</sub>  | Bus Drainage Test                              |                 | 0.0             | V <sub>OUT</sub> = 5.5V, All Others GND                                                                     |      |      | 100  | μA     |
| I <sub>CCH</sub> | Power Supply Current                           |                 | Max.            | All Outputs HIGH                                                                                            |      |      | 50   | μA     |
| I <sub>CCL</sub> | Power Supply Current                           |                 | Max.            | All Outputs LOW                                                                                             |      |      | 30   | mA     |
| I <sub>CCZ</sub> | Power Supply Current                           |                 | Max.            | $\overline{OE}$ = V <sub>CC</sub> , All Others at V <sub>CC</sub> or GND                                    |      |      | 50   | μA     |
| I <sub>CCT</sub> | Additional I <sub>CC</sub> /Input              | Outputs Enabled | Max.            | V <sub>I</sub> = V <sub>CC</sub> - 2.1V                                                                     |      |      | 2.5  | mA     |
|                  |                                                | Outputs 3-STATE |                 | Enable Input V <sub>I</sub> = V <sub>CC</sub> - 2.1V                                                        |      |      | 2.5  | mA     |
|                  |                                                | Outputs 3-STATE |                 | Data Input V <sub>I</sub> = V <sub>CC</sub> - 2.1V, All Others at V <sub>CC</sub> or GND                    |      |      | 2.5  | mA     |
| I <sub>CCD</sub> | Dynamic I <sub>CC</sub> No Load <sup>(3)</sup> |                 | Max.            | Outputs Open, $\overline{OE}$ = GND, LE = V <sub>CC</sub> <sup>(2)</sup> , One-Bit Toggling, 50% Duty Cycle |      |      | 0.12 | mA/MHz |

## Notes:

- For 8-bits toggling, I<sub>CCD</sub> < 0.8mA/MHz.
- Guaranteed but not tested.

## DC Electrical Characteristics

SOIC package.

| Symbol           | Parameter                                    | V <sub>CC</sub> | Conditions<br>C <sub>L</sub> = 50pF,<br>R <sub>L</sub> = 500Ω | Min. | Typ. | Max. | Units |
|------------------|----------------------------------------------|-----------------|---------------------------------------------------------------|------|------|------|-------|
| V <sub>OLP</sub> | Quiet Output Maximum Dynamic V <sub>OL</sub> | 5.0             | T <sub>A</sub> = 25°C <sup>(4)</sup>                          |      | 0.7  | 1.0  | V     |
| V <sub>OLV</sub> | Quiet Output Minimum Dynamic V <sub>OL</sub> | 5.0             | T <sub>A</sub> = 25°C <sup>(4)</sup>                          | −1.5 | −1.2 |      | V     |
| V <sub>OHV</sub> | Minimum HIGH Level Dynamic Output Voltage    | 5.0             | T <sub>A</sub> = 25°C <sup>(5)</sup>                          | 2.5  | 3.0  |      | V     |
| V <sub>IHD</sub> | Minimum HIGH Level Dynamic Input Voltage     | 5.0             | T <sub>A</sub> = 25°C <sup>(6)</sup>                          | 2.2  | 1.8  |      | V     |
| V <sub>ILD</sub> | Maximum LOW Level Dynamic Input Voltage      | 5.0             | T <sub>A</sub> = 25°C <sup>(6)</sup>                          |      | 1.0  | 0.7  | V     |

### Notes:

- Max number of outputs defined as (n). n – 1 data inputs are driven 0V to 3V. One output at LOW. Guaranteed, but not tested.
- Max number of outputs defined as (n). n – 1 data inputs are driven 0V to 3V. One output HIGH. Guaranteed, but not tested.
- Max number of data inputs (n) switching. n – 1 inputs switching 0V to 3V. Input-under-test switching: 3V to threshold (V<sub>ILD</sub>), 0V to threshold (V<sub>IHD</sub>). Guaranteed, but not tested.

## AC Electrical Characteristics

SOIC and SSOP package.

| Symbol           | Parameter                                           | T <sub>A</sub> = +25°C,<br>V <sub>CC</sub> = +5.0V,<br>C <sub>L</sub> = 50pF |      |      | T <sub>A</sub> = −40°C to +85°C,<br>V <sub>CC</sub> = 4.5V to 5.5V,<br>C <sub>L</sub> = 50pF |      | Units |
|------------------|-----------------------------------------------------|------------------------------------------------------------------------------|------|------|----------------------------------------------------------------------------------------------|------|-------|
|                  |                                                     | Min.                                                                         | Typ. | Max. | Min.                                                                                         | Max. |       |
| t <sub>PLH</sub> | Propagation Delay, D <sub>n</sub> to O <sub>n</sub> | 1.9                                                                          | 2.7  | 4.5  | 1.9                                                                                          | 4.5  | ns    |
| t <sub>PHL</sub> |                                                     | 1.9                                                                          | 2.8  | 4.5  | 1.9                                                                                          | 4.5  |       |
| t <sub>PLH</sub> | Propagation Delay, LE to O <sub>n</sub>             | 2.0                                                                          | 3.1  | 5.0  | 2.0                                                                                          | 5.0  | ns    |
| t <sub>PHL</sub> |                                                     | 2.0                                                                          | 3.0  | 5.0  | 2.0                                                                                          | 5.0  |       |
| t <sub>PZH</sub> | Output Enable Time                                  | 1.5                                                                          | 3.1  | 5.3  | 1.5                                                                                          | 5.3  | ns    |
| t <sub>PZL</sub> |                                                     | 1.5                                                                          | 3.1  | 5.3  | 1.5                                                                                          | 5.3  |       |
| t <sub>PHZ</sub> | Output Disable Time                                 | 2.0                                                                          | 3.6  | 5.4  | 2.0                                                                                          | 5.4  | ns    |
| t <sub>PLZ</sub> |                                                     | 2.0                                                                          | 3.4  | 5.4  | 2.0                                                                                          | 5.4  |       |

**AC Operating Requirements**

SOIC and SSOP package.

| Symbol                   | Parameter                          | $T_A = +25^\circ\text{C}$ ,<br>$V_{CC} = +5.0\text{V}$ ,<br>$C_L = 50\text{pF}$ |      |      | $T_A = -40^\circ\text{C to } +85^\circ\text{C}$ ,<br>$V_{CC} = 4.5\text{V to } 5.5\text{V}$ ,<br>$C_L = 50\text{pF}$ |      | Units |
|--------------------------|------------------------------------|---------------------------------------------------------------------------------|------|------|----------------------------------------------------------------------------------------------------------------------|------|-------|
|                          |                                    | Min.                                                                            | Typ. | Max. | Min.                                                                                                                 | Max. |       |
| $f_{\text{TOGGLE}}$      | Max Toggle Frequency               |                                                                                 | 100  |      |                                                                                                                      |      | MHz   |
| $t_{\text{S}}(\text{H})$ | Set Time, HIGH or LOW $D_n$ to LE  | 1.5                                                                             |      |      | 1.5                                                                                                                  |      | ns    |
| $t_{\text{S}}(\text{L})$ |                                    | 1.5                                                                             |      |      | 1.5                                                                                                                  |      |       |
| $t_{\text{H}}(\text{H})$ | Hold Time, HIGH or LOW $D_n$ to LE | 1.0                                                                             |      |      | 1.0                                                                                                                  |      | ns    |
| $t_{\text{H}}(\text{L})$ |                                    | 1.0                                                                             |      |      | 1.0                                                                                                                  |      |       |
| $t_{\text{W}}(\text{H})$ | Pulse Width, LE HIGH               | 3.0                                                                             |      |      | 3.0                                                                                                                  |      | ns    |

**Extended AC Electrical Characteristics**

SOIC package.

| Symbol    | Parameter                            | $T_A = -40^{\circ}\text{C to } +85^{\circ}\text{C}$ ,<br>$V_{CC} = 4.5\text{V to } 5.5\text{V}$ ,<br>$C_L = 50\text{pF}$ ,<br>8 Outputs<br>Switching <sup>(7)</sup> |      | $T_A = -40^{\circ}\text{C to } +85^{\circ}\text{C}$ ,<br>$V_{CC} = 4.5\text{V to } 5.5\text{V}$ ,<br>$C_L = 250\text{pF}$ <sup>(8)</sup> |      | $T_A = -40^{\circ}\text{C to } +85^{\circ}\text{C}$ ,<br>$V_{CC} = 4.5\text{V to } 5.5\text{V}$ ,<br>$C_L = 250\text{pF}$ ,<br>8 Outputs<br>Switching <sup>(9)</sup> |      | Units |
|-----------|--------------------------------------|---------------------------------------------------------------------------------------------------------------------------------------------------------------------|------|------------------------------------------------------------------------------------------------------------------------------------------|------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------|------|-------|
|           |                                      | Min.                                                                                                                                                                | Max. | Min.                                                                                                                                     | Max. | Min.                                                                                                                                                                 | Max. |       |
| $t_{PLH}$ | Propagation Delay,<br>$D_n$ to $O_n$ | 1.5                                                                                                                                                                 | 5.2  | 2.0                                                                                                                                      | 6.8  | 2.0                                                                                                                                                                  | 9.0  | ns    |
| $t_{PHL}$ |                                      | 1.5                                                                                                                                                                 | 5.2  | 2.0                                                                                                                                      | 6.8  | 2.0                                                                                                                                                                  | 9.0  |       |
| $t_{PLH}$ | Propagation Delay,<br>LE to $O_n$    | 1.5                                                                                                                                                                 | 5.5  | 2.0                                                                                                                                      | 7.5  | 2.0                                                                                                                                                                  | 9.5  | ns    |
| $t_{PHL}$ |                                      | 1.5                                                                                                                                                                 | 5.5  | 2.0                                                                                                                                      | 7.5  | 2.0                                                                                                                                                                  | 9.5  |       |
| $t_{PZH}$ | Output Enable<br>Time                | 1.5                                                                                                                                                                 | 6.2  | 2.0                                                                                                                                      | 8.0  | 2.0                                                                                                                                                                  | 10.5 | ns    |
| $t_{PZL}$ |                                      | 1.5                                                                                                                                                                 | 6.2  | 2.0                                                                                                                                      | 8.0  | 2.0                                                                                                                                                                  | 10.5 |       |
| $t_{PHZ}$ | Output Disable<br>Time               | 1.0                                                                                                                                                                 | 5.5  | (10)                                                                                                                                     |      | (10)                                                                                                                                                                 |      | ns    |
| $t_{PLZ}$ |                                      | 1.0                                                                                                                                                                 | 5.5  |                                                                                                                                          |      |                                                                                                                                                                      |      |       |

**Notes:**

- This specification is guaranteed but not tested. The limits apply to propagation delays for all paths described switching in phase (i.e., all LOW-to-HIGH, HIGH-to-LOW, etc.).
- This specification is guaranteed but not tested. The limits represent propagation delay with 250pF load capacitors in place of the 50pF load capacitors in the standard AC load. This specification pertains to single output switching only.
- This specification is guaranteed but not tested. The limits represent propagation delays for all paths described switching in phase (i.e., all LOW-to-HIGH, HIGH-to-LOW, etc.) with 250 pF load capacitors in place of the 50pF load capacitors in the standard AC load.
- The 3-STATE delay times are dominated by the RC network (500Ω, 250pF) on the output and has been excluded from the datasheet.

**Skew<sup>(11)</sup>**

SOIC package.

| Symbol            | Parameter                               | $T_A = -40^{\circ}\text{C to } +85^{\circ}\text{C}$ ,<br>$V_{CC} = 4.5\text{V to } 5.5\text{V}$ ,<br>$C_L = 50\text{pF}$ ,<br>8 Outputs<br>Switching <sup>(11)</sup> | $T_A = -40^{\circ}\text{C to } +85^{\circ}\text{C}$ ,<br>$V_{CC} = 4.5\text{V to } 5.5\text{V}$ ,<br>$C_L = 250\text{pF}$ ,<br>8 Outputs<br>Switching <sup>(12)</sup> | Units |
|-------------------|-----------------------------------------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------|-------|
|                   |                                         | Max.                                                                                                                                                                 | Max.                                                                                                                                                                  |       |
| $t_{OSHL}^{(13)}$ | Pin to Pin Skew, HL Transitions         | 1.0                                                                                                                                                                  | 1.5                                                                                                                                                                   | ns    |
| $t_{OSLH}^{(13)}$ | Pin to Pin Skew, LH Transitions         | 1.0                                                                                                                                                                  | 1.5                                                                                                                                                                   | ns    |
| $t_{PS}^{(14)}$   | Duty Cycle, LH–HL Skew                  | 1.4                                                                                                                                                                  | 3.5                                                                                                                                                                   | ns    |
| $t_{OST}^{(13)}$  | Pin to Pin Skew, LH/HL Transitions      | 1.5                                                                                                                                                                  | 3.9                                                                                                                                                                   | ns    |
| $t_{PV}^{(15)}$   | Device to Device Skew LH/HL Transitions | 2.0                                                                                                                                                                  | 4.0                                                                                                                                                                   | ns    |

**Notes:**

11. This specification is guaranteed but not tested. The limits apply to propagation delays for all paths described switching in phase (i.e., all LOW-to-HIGH, HIGH-to-LOW, etc.)
12. This specification is guaranteed but not tested. The limits represent propagation delays with 250pF load capacitors in place of the 50pF load capacitors in the standard AC load.
13. Skew is defined as the absolute value of the difference between the actual propagation delays for any two separate outputs of the same device. The specification applies to any outputs switching HIGH-to-LOW ( $t_{OSHL}$ ), LOW-to-HIGH ( $t_{OSLH}$ ), or any combination switching LOW-to-HIGH and/or HIGH-to-LOW ( $t_{OST}$ ). This specification is guaranteed but not tested.
14. This describes the difference between the delay of the LOW-to-HIGH and the HIGH-to-LOW transition on the same pin. It is measured across all the outputs (drivers) on the same chip, the worst (largest delta) number is the guaranteed specification. This specification is guaranteed but not tested.
15. Propagation delay variation for a given set of conditions (i.e., temperature and  $V_{CC}$ ) from device to device. This specification is guaranteed but not tested.

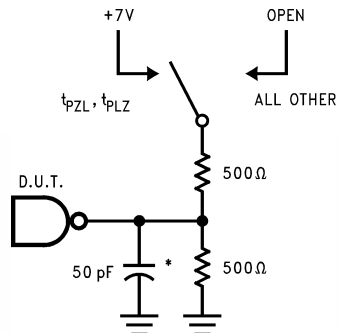
**Capacitance**

| Symbol           | Parameter          | Conditions<br>( $T_A = 25^{\circ}\text{C}$ ) | Typ. | Units |
|------------------|--------------------|----------------------------------------------|------|-------|
| $C_{IN}$         | Input Capacitance  | $V_{CC} = 0\text{V}$                         | 5    | pF    |
| $C_{OUT}^{(16)}$ | Output Capacitance | $V_{CC} = 5.0\text{V}$                       | 9    | pF    |

**Note:**

16.  $C_{OUT}$  is measured at frequency  $f = 1\text{MHz}$  per MIL-STD-883B, Method 3012.

## AC Loading



\*Includes jig and probe capacitance

Figure 1. Test Load

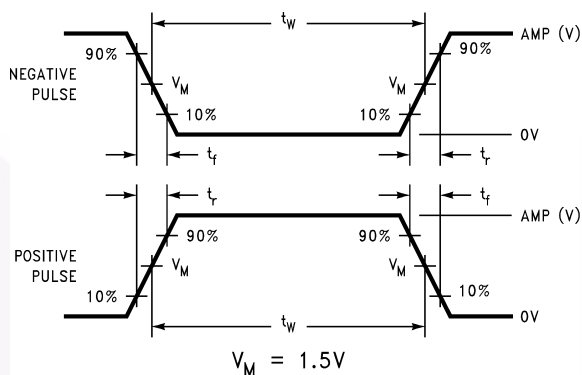


Figure 2. Test Input Signal Levels

| Amplitude | Rep. Rate | $t_W$ | $t_r$ | $t_f$ |
|-----------|-----------|-------|-------|-------|
| 3.0V      | 1MHz      | 500ns | 2.5ns | 2.5ns |

Figure 3. Test Input Signal Requirements

## AC Waveforms

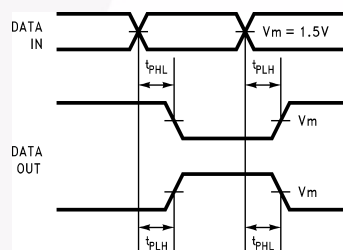


Figure 4. Propagation Delay Waveforms for Inverting and Non-Inverting Functions

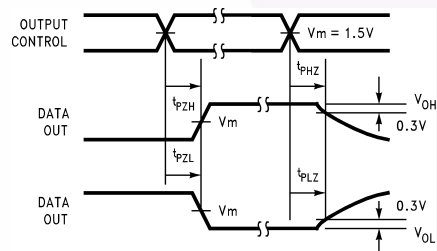


Figure 6. 3-STATE Output HIGH and LOW Enable and Disable Times

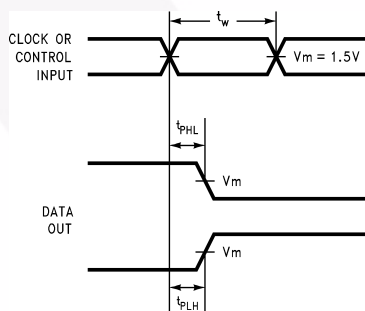


Figure 5. Propagation Delay, Pulse Width Waveforms

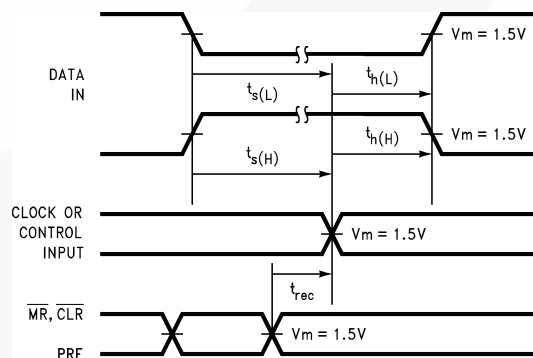


Figure 7. Setup Time, Hold Time and Recovery Time Waveforms

## Physical Dimensions



Figure 8. 20-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-013, 0.300" Wide

Package drawings are provided as a service to customers considering Fairchild components. Drawings may change in any manner without notice. Please note the revision and/or date on the drawing and contact a Fairchild Semiconductor representative to verify or obtain the most recent revision. Package specifications do not expand the terms of Fairchild's worldwide terms and conditions, specifically the warranty therein, which covers Fairchild products.

Always visit Fairchild Semiconductor's online packaging area for the most recent package drawings:

<http://www.fairchildsemi.com/packaging/>

## Physical Dimensions (Continued)



M20DREVC

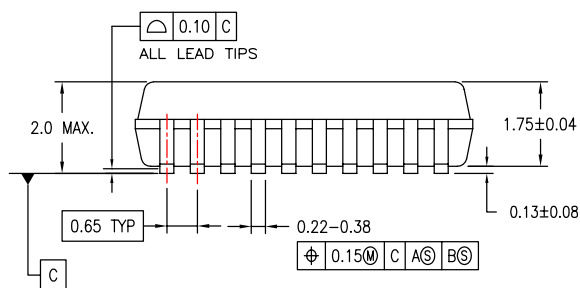
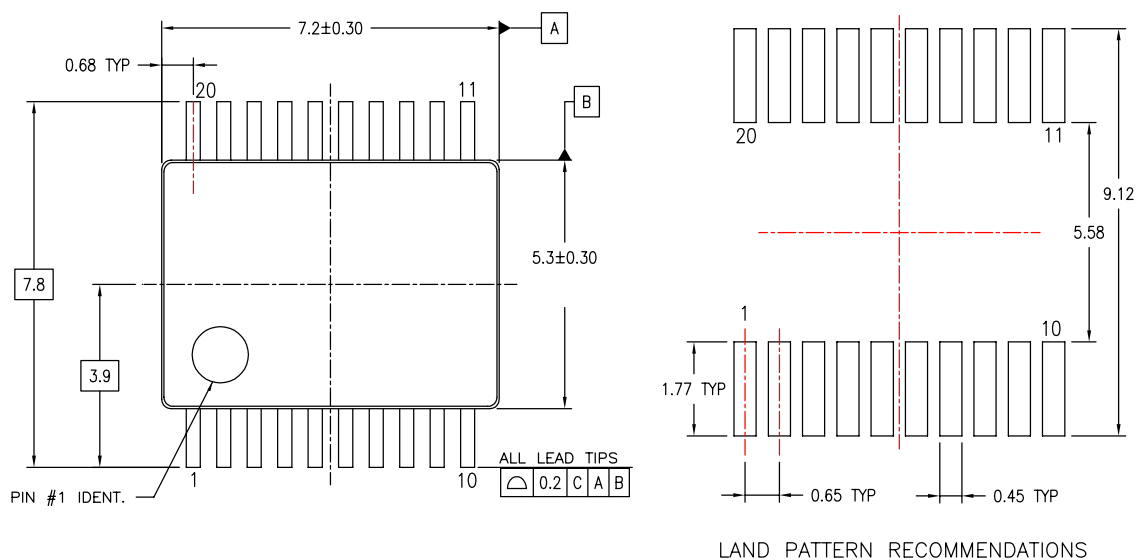
Figure 9. 20-Lead Small Outline Package (SOP), EIAJ TYPE II, 5.3mm Wide

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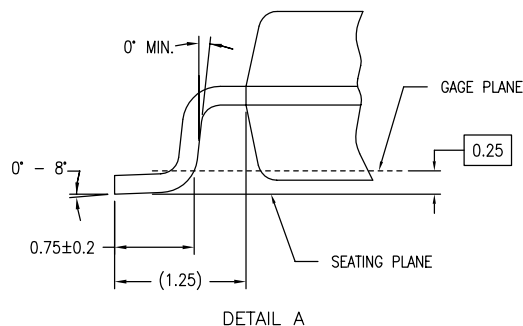
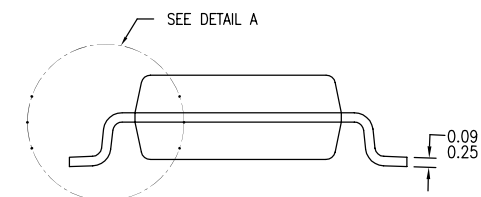
## Physical Dimensions (Continued)



DIMENSIONS ARE IN MILLIMETERS

## NOTES:

- CONFORMS TO JEDEC REGISTRATION MO-150, VARIATION AE, DATE 1/94.
- DIMENSIONS ARE IN MILLIMETERS.
- DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD FLASH, AND TIE BAR EXTRUSIONS.
- DIMENSIONS AND TOLERANCES PER ASME Y14.5M - 1994.



MSA20REVB

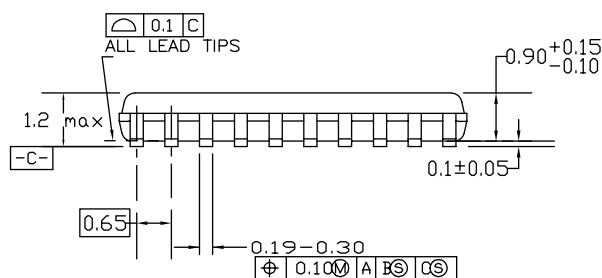
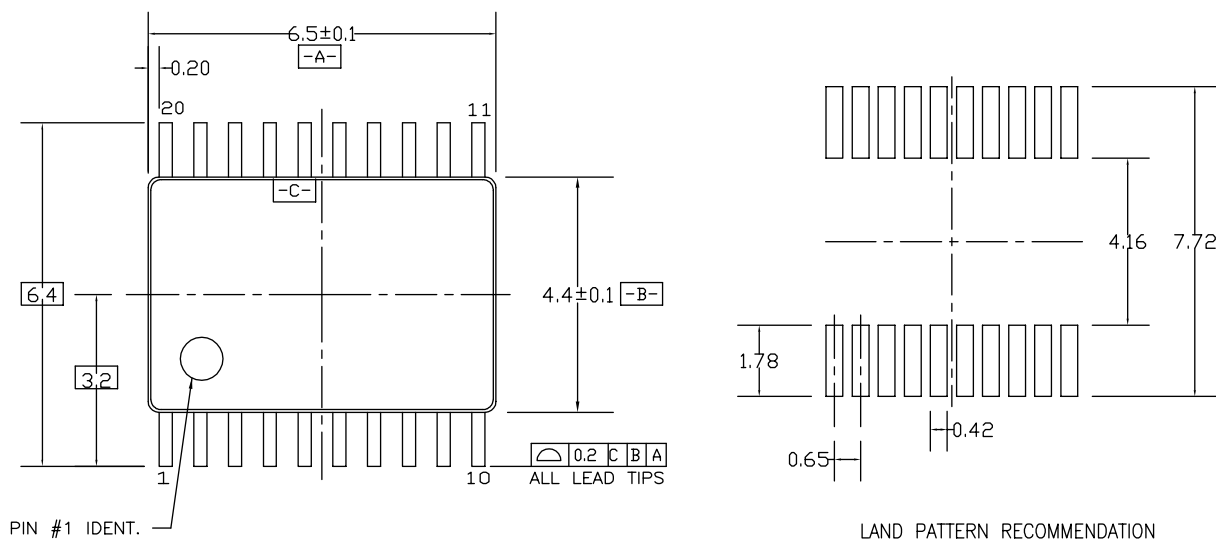
Figure 10. 20-Lead Shrink Small Outline Package (SSOP), JEDEC MO-150, 5.3mm Wide

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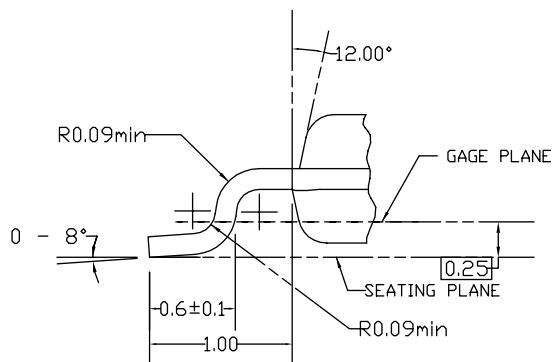
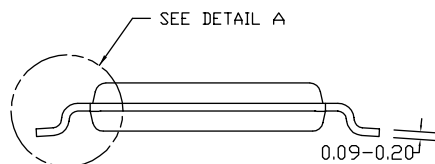
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# Physical Dimensions (Continued)



DIMENSIONS ARE IN MILLIMETERS



DETAIL A

## NOTES:

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- DIMENSIONS ARE IN MILLIMETERS.
- DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLDS FLASH, AND TIE BAR EXTRUSIONS.
- DIMENSIONS AND TOLERANCES PER ANSI Y14.5M, 1982.

MTC20REV D1

Figure 11. 20-Lead Thin Shrink Small Outline Package (TSSOP), JEDEC MO-153, 4.4mm Wide

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|--------------------------|------------------------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
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Rev. I32

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